



SinglFuse™ SF-1206SPxxxM Series Features

- Single blow fuse for overcurrent protection
- 3216 (EIA 1206) footprint
- Time Lag fuse
- UL 248-14 listed
- RoHS compliant* and halogen free**
- Multilayer SMD design
- Surface mount packaging for automated assembly

SF-1206SPxxxM Series - Time Lag Multilayer Surface Mount Fuses

Electrical Characteristics

Model	Rated Current (Amps)	Fusing Time	Resistance (Ω) Typ.***	Rated Voltage	Interrupting Rating	Typical I ² t (A ² s) ****
SF-1206SP100M-2	1.00	Open within 120 sec. at 200 % rated current	0.360	DC 63 V	DC 63 V 50 A	0.11
SF-1206SP125M-2	1.25		0.200			0.22
SF-1206SP150M-2	1.50		0.150			0.23
SF-1206SP200M-2	2.00		0.088			0.63
SF-1206SP250M-2	2.50		0.065	DC 32V	DC 32 V 50 A	0.90
SF-1206SP300M-2	3.00		0.034			1.20
SF-1206SP350M-2	3.50		0.028			1.60
SF-1206SP400M-2	4.00		0.024			2.20
SF-1206SP450M-2	4.50		0.020	DC 24V	DC 24 V 60 A	3.60
SF-1206SP500M-2	5.00		0.018			5.30
SF-1206SP550M-2	5.50		0.014			6.40
SF-1206SP600M-2	6.00		0.011			8.50
SF-1206SP700M-2	7.00		0.010	DC 24V	DC 24 V 60 A	10.0
SF-1206SP800M-2	8.00		0.009			16.9

*** Resistance value measured with ≤10 % rated current at 25 °C ambient.

**** Melting I²t calculated at 0.001 second pre-arcing time.

Reliability Testing

No.	Test	Requirement	Test Condition	Test Reference
1	Soldering heat resistance	DCR change ≤ ±10 % No mechanical damage	One dip at 260 °C for 60 seconds	MIL-STD-202 Method 210
2	Solderability	Minimum 95 % coverage	One dip at 245 °C for 5 seconds	MIL-STD-202 Method 208
3	Thermal shock	DCR change ≤ ±10 % No mechanical damage	100 cycles between -65 °C and +125 °C	MIL-STD-202 Method 107
4	Moisture resistance	DCR change ≤ ±15 % No excessive corrosion	10 cycles	MIL-STD-202 Method 106
5	Salt spray	DCR change ≤ ±10 % No excessive corrosion	48 hour exposure, 5 % salt solution	MIL-STD-202 Method 101
6	Mechanical vibration	DCR change ≤ ±10 % No mechanical damage	0.4 inch D.A. or 30 G between 5-3000 Hz	MIL-STD-202 Method 204
7	Mechanical shock	DCR change ≤ ±10 % No mechanical damage	1500 G, 0.5 ms, half-sine shocks	MIL-STD-202 Method 213
8	Life	No electrical "opens" during testing Voltage drop change shall be less than ±20 % of initial value	80 % rated current (75 % for < 1 A fuses) for 2000 hours at ambient temperature between +20 °C and +30 °C	Refer to STP document

Agency Recognition

UL File Number E198545

<http://www.ul.com/> Follow link to Online Certificates Directory, then enter UL File No. E198545, or [click here](#)

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* RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

** Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less.

"SinglFuse" is a trademark of Bourns, Inc.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

SingIFuse™ SF-1206SPxxxM Series Applications

- Portable memory
 - LCD monitors
 - Disk drives
 - PDAs
 - Digital cameras
 - MP3 players
- Cell phones
 - Rechargeable battery packs
 - Battery chargers
 - Set-top boxes
 - Industrial controllers
 - Battery Management Systems (BMS)
- LED lighting
 - Power tools

SF-1206SPxxxM Series - Time Lag Multilayer Surface Mount Fuses **BOURNS®**

Environmental Characteristics

Operating Temperature.....	-55 °C to +150 °C
Storage Conditions	
Temperature	+5 °C to +35 °C
Humidity.....	40 % to 75 %
Shelf Life.....	2 years from manufacturing date
Moisture Sensitivity Level.....	1
ESD Classification (HBM).....	Class 6

Typical Part Marking

Represents total content. Layout may vary.



RATED CURRENT (A)

E = 1.00	M = 4.00
F = 1.25	T = 4.50
G = 1.50	N = 5.00
I = 2.00	U = 5.50
J = 2.50	O = 6.00
K = 3.00	P = 7.00
L = 3.50	R = 8.00

How to Order

SF - 1206 SP 100 M - 2

SingIFuse™
 Product Designator
 SMD Footprint
 1206 = 3216 (EIA 1206) size
 Fuse Blow Type
 SP = Time Lag
 Rated Current
 100 ~ 800 (1.00 A ~ 8.00 A)
 Structure Type
 M = Multilayer
 Packaging Type
 - 2 = Tape & Reel

Construction



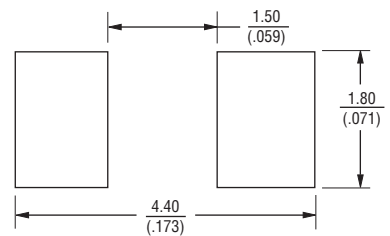
Packaging Quantity

3,000 pieces per 7-inch reel

Product Dimensions



Recommended Pad Layout



Current Rating Thermal Derating Curve



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SF-1206SPxxxM Series - Time Lag Multilayer Surface Mount Fuses



Solder Reflow Recommendations



Profile Feature	Pb-Free Assembly
Preheat / Soak: Temperature Min. (T_{smin}) Temperature Max. (T_{smax}) Time (t_s) from (T_{smin} to T_{smax})	150 °C 200 °C 60~120 seconds
Ramp Up Rate (T_l to T_d)	3 °C / second max.
Liquidous Temperature (T_l) Time (t_L) maintained above T_l	217 °C 60~150 seconds
Peak Package Body Temperature (T_d)	260 °C
Time (t_p)* within 5 °C of the specified classification temperature (T_c)	30 seconds*
Ramp Down Rate (T_d to T_l)	6 °C / second max.
Time 25 °C to Peak Temperature	8 minutes max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

Recommended Temperature Profile for Wave Soldering

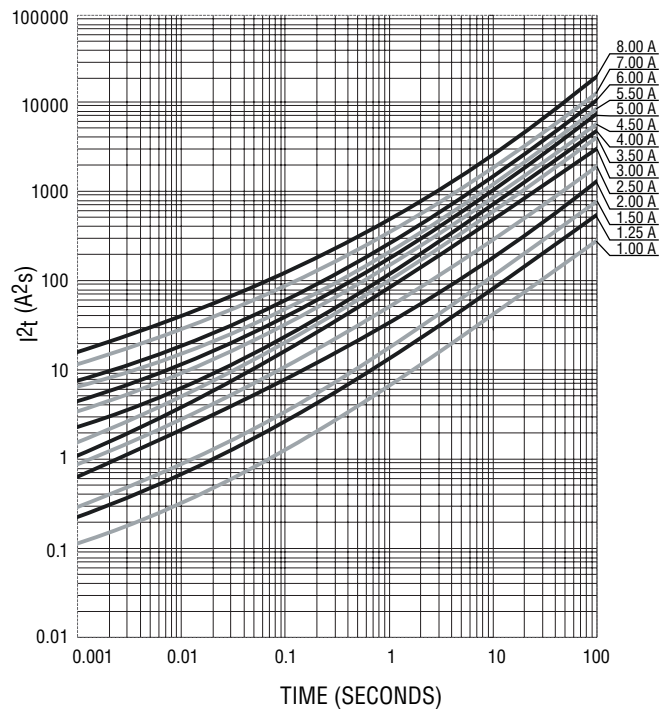


Wave soldering is suitable for 1206 size models.

Average Pre-Arcing Time vs. Current Curves



Average I^2t vs. t Curves



REV. B 03/18

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SF-1206SPxxxM Series Tape and Reel Packaging Specifications

BOURNS®

SF-1206SPxxxM Series per EIA 481-2

Tape Dimensions

W	$\frac{8.00 \pm 0.10}{(.315 \pm .004)}$
P ₀	$\frac{4.0 \pm 0.10}{(.157 \pm .004)}$
P ₁	$\frac{4.0 \pm 0.10}{(.157 \pm .004)}$
P ₂	$\frac{2.0 \pm 0.05}{(.079 \pm .002)}$
A ₀	$\frac{1.80 \pm 0.10}{(.071 \pm .004)}$
B ₀	$\frac{3.50 \pm 0.10}{(.138 \pm .004)}$
F	$\frac{3.50 \pm 0.05}{(.138 \pm .002)}$
E ₁	$\frac{1.75 \pm 0.10}{(.069 \pm .004)}$
D ₀	$\frac{1.50 \pm 0.10}{(.059 \pm .004)}$
K ₀	$\frac{1.10 \pm 0.10}{(.043 \pm .004)}$
T	$\frac{0.23 \pm 0.02}{(.009 \pm .001)}$

PACKAGING: Plastic tape, 3,000 pcs. per reel



DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

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Данный компонент на территории Российской Федерации

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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